# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Kohji Tsukagoshi	09/06/2007

### **RECEIVING PARTY DATA**

Name:	Sanken Electric Co., Ltd.
Street Address:	6-3, Kitano 3-chome, Niiza-shi,
City:	Saitama
State/Country:	JAPAN
Postal Code:	352-8666

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11947844

## **CORRESPONDENCE DATA**

Fax Number: (203)865-0297

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 203-777-6628

Email: rachel@bachlap.com

Correspondent Name: BACHMAN & LAPOINTE, P.C.

Address Line 1: 900 CHAPEL STREET

Address Line 2: SUITE 1201

Address Line 4: NEW HAVEN, CONNECTICUT 06510

ATTORNEY DOCKET NUMBER: 07-588

NAME OF SUBMITTER: Gregory P. LaPointe

Total Attachments: 1

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CH \$40.00

PATENT REEL: 020179 FRAME: 0279

# **ASSIGNMENT**

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned, Kohji Tsukagoshi

Hereby sell, assign and transfer to Sanken Electric Co., Ltd. a corporation of Japan

Having a place of business at 6-3, Kitano 3-chome, Niiza-shi, Saitama, 352-8666 Japan

its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled SEMICONDUCTOR LIGHT EMITTING DEVICE EXCELLENT IN HEAT RADIATION

, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date September 6,2007	Kohji Tsukagoshi (LS)
Date	(L.S.)
Date	(LS)
Date	(LS.)

PATENT REEL: 020179 FRAME: 0280

**RECORDED: 11/30/2007**